

FAIRCHILD

SEMICONDUCTOR®

General Description

FIN1049

March 2003 Revised March 2003

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LVDS Dual Line Driver with Dual Line Receiver

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IN1049 LVDS Dual Line Driver with Dual Line Receiver

This dual Driver-Receiver is designed for high speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The Driver accepts LVTTL inputs and translates them to LVDS outputs. The Receiver accepts LVDS inputs and translates them to LVTTL outputs. The LVDS levels have a typical differential output swing of 350mV which provide for low EMI at ultra low power dissipation even at high frequencies. The FIN1049 can accept LVPECL inputs for translating from LVPECL to LVDS. The En and Enb inputs are ANDed together to enable/disable the outputs. The enables are common to all four outputs. A single line driver and single line receiver function is also available in the FIN1019.

Features

- Greater than 400 Mbps data rate
- 3.3V power supply operation
- Low power dissipation
- Fail safe protection for open-circuit conditions
- Meets or exceeds the TIA/EIA-644-A LVDS standard
- 16-pin TSSOP package saves space
- Flow-through pinout simplifies PCB layout
- Enable/Disable for all outputs
- Industrial operating temperature range: -40°C to +85°C

Ordering Code:

		A A A A A A A A A A A A A A A A A A A	
	Order Number	Package Number	Package Description
	FIN1049MTC	MTC16	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code			

Pin Descriptions

Pin Name	Description
R _{IN1+} , R _{IN2+}	Non-Inverting LVDS Inputs
R _{IN1-} , R _{IN2-}	Inverting LVDS Inputs
D _{OUT1+} , D _{OUT2+}	Non-Inverting Driver Outputs
D _{OUT1-} , D _{OUT2-}	Inverting Driver Outputs
EN, ENb	Driver Enable Pins for All Outputs
R _{OUT1} , R _{OUT2}	LVTTL Output Pins for R _{OUT1} and R _{OUT2}
D _{IN2} , D _{IN2}	LVTTL Input Pins for D _{IN1} and D _{IN2}
V _{CC}	Power Supply (3.3V)
GND	Ground

Connection Diagram

R _{IN1-}	1	16 — EN
R _{IN1+} -	2	15 - R _{OUT1}
R _{IN2+} -	3	14 - R _{OUT2}
R _{IN2-} -	4	13 – GND
Dout2	5	12 – V _{DD}
Dout2+ -	6	11 – D _{IN2}
Dout1+ -	7	10 - DIN1
D _{OUT1-}	8	9 — ENb

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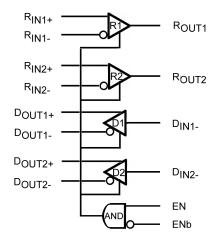
FIN1049 **Function Table**

Inputs		Outputs	Outputs (LVTTL)		Inputs (LVDS) (Note 1)		Outputs (LVDS)	
EN	ENb	R _{OUT1}	R _{OUT2}	R _{IN#+}	R _{IN#-}	D _{OUT#+}	D _{OUT#-}	
Н	L	ON	ON			ON	ON	
Н	н	Z	Z			Z	Z	
L	Н	Z	Z			Z	Z	
L	L	Z	Z			Z	Z	
н	L	Н	н		Current Condition			

H = HIGH Logic Level L = LOW Logic Level or OPEN X = Don't Care Z = High Impedance

Note 1: Any unused Receiver Inputs should be left Open.

Functional Diagram



Absolute Maximum Ratings(Note 2)

Supply Voltage (V _{CC})	-0.5V to +4.6V
LVDS DC Input Voltage (VIN)	-0.5V to +4.6V
LVDS DC Output Voltage (V _{OUT})	-0.5V to +4.6V
Driver Short Circuit Current (I _{OSD})	Continuous 10mA
Storage Temperature Range (T _{STG})	–65°C to +150°C
Max Junction Temperature (T _J)	150°C
Lead Temperature (T _L)	
(Soldering, 10 seconds)	260°C
ESD (Human Body Model)	>7000V
ESD (Machine Model)	>250V

Recommended Operating Conditions

o +4.6V	Supply Voltage (V _{CC})	3.0V to 3.6V
o +4.6V	Magnitude of Differential Voltage	
s 10mA	(V _{ID})	100mV to V_{CC} -40°C to +85°C
+150°C	Operating Temperature (T _A)	-40°C to +85°C
150°C		

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 260°C
 Note 2: The "Absolute Maximum Ratings": are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specification.

DC Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 3)	Max	Units
	LVDS Input DC S	pecifications (R _{IN1+} , R _{IN1-} , R _{IN2+} , R _{IN2-}) See Fi	gure 1 and 1			
V _{TH}	Differential Input Threshold HIGH			0.0	35.0	mV
V _{TL}	Differential Input Threshold LOW	VCM = 1.2V, 0.05V, 2.35V	-100	0.0		mV
VIC	Common Mode Voltage Range	$V_{ID} = 100 \text{mV}, V_{CC} = 3.3 \text{V}$	V _{ID} /2		$V_{CC} - (V_{ID}/2)$	V
I _{IN}	Input Current	$V_{CC} = 0V \text{ or } 3.6V, V_{IN} = 0V \text{ or } 2.8V$			±20.0	mA
	CMOS/	LVTTL Input DC Specifications (EN, ENb, D	_{N1} , D _{IN2})			
VIH	Input High Voltage (LVTTL)		2.0		V _{CC}	V
VIL	Input Low Voltage (LVTTL)		GND		0.8	V
I _{IN}	Input Current					
	(EN, ENb, $D_{IN1},D_{IN2},R_{INx+},\text{and}$ $R_{INx-})$	$V_{IN} = 0V \text{ or } V_{CC}$			±20.0	μA
V _{IK}	Input Clamp Voltage	$V_{IK} = -18 \text{mA}$	-1.5	-0.7		V
	LVDS Out	put DC Specifications (D _{OUT1+} , D _{OUT1-} , D _{OUT}	-2+, D _{OUT2-})			
V _{OD}	Output Differential Voltage		250	350	450	mV
ΔV_{OD}	V _{OD} Magnitude Change from	$R_L = 100\Omega$,			35.0	mV
	Differential LOW-to-HIGH	Driver Enabled,			33.0	IIIV
V _{OS}	Offset Voltage	See Figure 2	1.125	1.25	1.375	V
ΔV_{OS}	Offset Magnitude Change from				25.0	mV
	Differential LOW-to-HIGH				23.0	IIIV
I _{OS}	Short Circuit Output Current	$D_{OUT+} = 0V \& D_{OUT-} = 0V$, Driver Enabled			-9.0	mA
I _{OSD}	Short Circuit Output Current	V _{OD} = 0V, Driver Enabled			-9.0	mA
I _{OFF}	Power-Off Input or Output Current	$V_{CC} = 0V, V_{OUT} = 0V \text{ or } V_{CC}$			±20.0	μΑ
I _{OZD}	Disabled Output Leakage Current	Driver Disabled, $D_{OUT+} = 0V$ or V_{CC}			±10.0	μA
		or $D_{OUT-} = 0V$ or V_{CC}			10.0	μΛ
	СМО	S/LVTTL Output DC Specifications (R _{OUT1} , F	R _{OUT2})			
V _{OH}	Output High Voltage	$I_{OH} = -2mA, V_{ID} = 200mV$	2.7			V
V _{OL}	Output Low Voltage	$I_{OL} = 2mA, V_{ID} = 200mV$			0.250	V
I _{OZ}	Disabled Output Leakage Current	Driver Disabled, $R_{OUTn} = 0V$ or V_{CC}			±10.0	μΑ
I _{CC}	Power Supply Current (Note 4)	Drivers Enabled, Any Valid Input Condition			25.0	mA
I _{CCZ}	Power Supply Current	Drivers Disabled			10.0	mA
C _{IND}	Input Capacitance	LVDS Input		3.0		pF
C _{OUT}	Output Capacitance	LVDS Output		4.0		pF
CINT	Input Capacitance	LVTTL Input		3.5		pF

Note 4: Both driver and receiver inputs are static. All LVDS outputs have 100Ω load. None of the outputs have any lumped capacitive load.

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AC Electrical Characteristics

oltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 5)	Max	Units
	Switching	Characteristics - LVDS Outputs				
t _{PLHD}	Differential Propagation Delay LOW-to-HIGH				2.0	ns
t _{PHLD}	Differential Propagation Delay HIGH-to-LOW	1			2.0	ns
t _{TLHD}	Differential Output Rise Time (20% to 80%)	1	0.2		1.0	ns
t _{THLD}	Differential Output Fall Time (80% to 20%)	See Figures 3, 4	0.2		1.0	ns
t _{SK(P)}	Pulse Skew t _{PLH} - t _{PHL}	See Figures 5, 4			0.35	ns
t _{SK(LH)} ,	Channel-to-Channel Skew (Note 6)				0.35	ns
t _{SK(HL)}						
t _{SK(PP)}	Part-to-Part Skew (Note 7)				1.0	ns
t _{PZHD}	Differential Output Enable Time from Z-to-HIGH				6.0	ns
t _{PZLD}	Differential Output Enable Time from A-to-LOW	See Figures 5, 6			6.0	ns
t _{PHZD}	Differential Output Disable Time from HIGH-to-Z				3.0	ns
t _{PLZD}	Differential Output Disable Time from LOW-to-Z				3.0	ns
f _{MAXD}	Maximum Frequency (Note 8)	See Figure 3	200			MHz
	Switching	Characteristics - LVTTL Outputs				
t _{PHL}	Propagation Delay HIGH-to-LOW	Measured from 20% to 80% signal	0.5	1.0	3.5	ns
t _{PLH}	Propagation Delay LOW-to-HIGH	$V_{ID} = 200 mV;$	0.5	1.0	3.5	ns
t _{SK1}	Pulse Skew	Distributed Load	0.0	35.0	400	ps
t _{SK2}	Channel-to-Channel Skew	$C_L = 15 pF$ and 50Ω ;	0.0	50.0	500	ps
t _{SK3}	Part-to-Part Skew	$R_L = 1K\Omega;$	0.0		1.0	ns
t _{LHR}	Transition Time LOW-to-HIGH	V _{OS} = 1.2V;	0.1	0.25	1.4	ns
t _{HLR}	Transition Time HIGH-to-LOW	See Figures 7, 8	0.1	0.18	1.4	ns
t _{PHZ}	Disable Time HIGH-to-Z		2.2	4.5	8.0	ns
t _{PLZ}	Disable Time LOW-to-Z	See Figures 9, 10	1.3	3.5	8.0	ns
t _{PZH}	Enable Time Z-to-HIGH		1.8	3.0	7.0	ns
t _{PZL}	Enable Time Z-to-LOW	1	0.9	1.4	7.0	ns
fMAXT	Maximum Frequency (Note 9)	See Figure 7	200			MHz

Note 5: All typical values are at $T_A=25^\circ C$ and with $V_{CC}=3.3 V.$

Note 6: $t_{SK(LH)}$, $t_{SK(HL)}$ is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same direction.

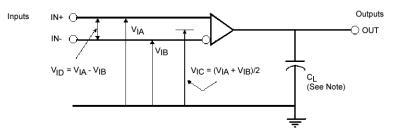
Note 7: t_{SK(PP)} is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits. Note 8: f_{MAX} generator input conditions: $t_r = t_f < 1ns$ (10% to 90%), 50% duty cycle, 0V to 3V. Output criteria: duty cycle = 45% / 55%, $V_{OD} > 250mV$, all chan-

nels switch.

Note 9: f_{MAXT} generator input conditions: $t_r = t_f < 1$ ns (10% to 90%), 50% duty cycle, $V_{ID} = 200$ mV, $V_{CM} = 1.2$ V. Output criteria: duty cycle = 45% / 55%, $V_{OH} > 2.7$ V. $V_{OL} < 0.25$ V, all channels switching.

Required Specifications

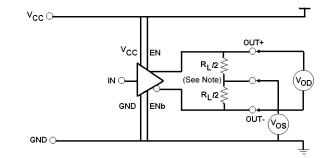
- Human Body Model ESD and Machine Model ESD should be measured using MIL-STD-883C method 3015.7 standard.
- Latch-up immunity should be tested to the EIA/JEDEC Standard Number 78 (EIA/JESD78).



Note: $C_L = 15 pF$, includes all probe and jig capacitances

FIGURE 1. Differential Receiver Voltage Definitions Test Circuit

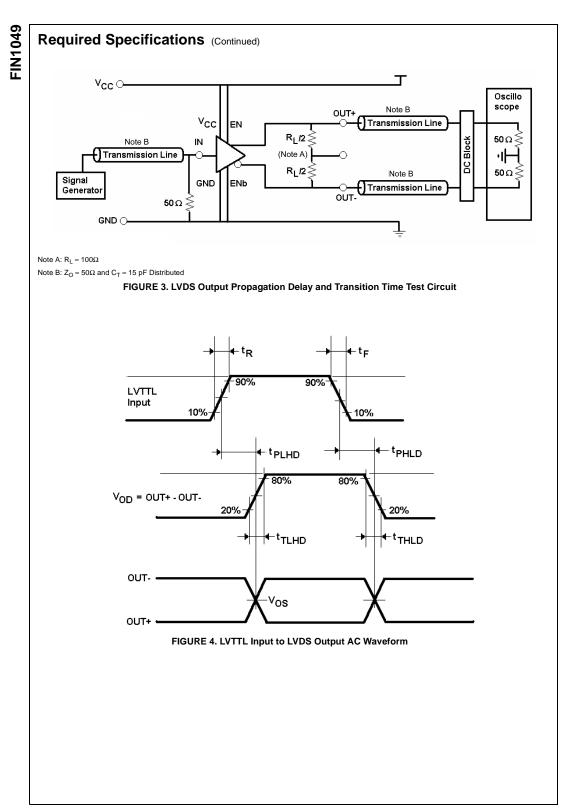
Applied Voltages (V)		Resulting Differential Input	Resulting Common
		Voltage (mV)	Mode Input Voltage (V)
VIA	VIB	V _{ID}	V _{IC}
1.25	1.15	100	1.2
1.15	1.25	-100	1.2
V _{CC}	V _{CC} - 0.1	100	V _{CC} - 0.05
V _{CC} - 0.1	V _{CC}	-100	V _{CC} - 0.05
0.1	0.0	100	0.05
0.0	0.1	-100	0.05
1.75	0.65	1100	1.2
0.65	1.75	-1100	1.2
V _{CC}	V _{CC} - 1.1	1100	V _{CC} - 0.55
V _{CC} - 1.1	V _{CC}	-1100	V _{CC} - 0.55
1.1	0.0	1100	0.55
0.0	1.1	-1100	0.55

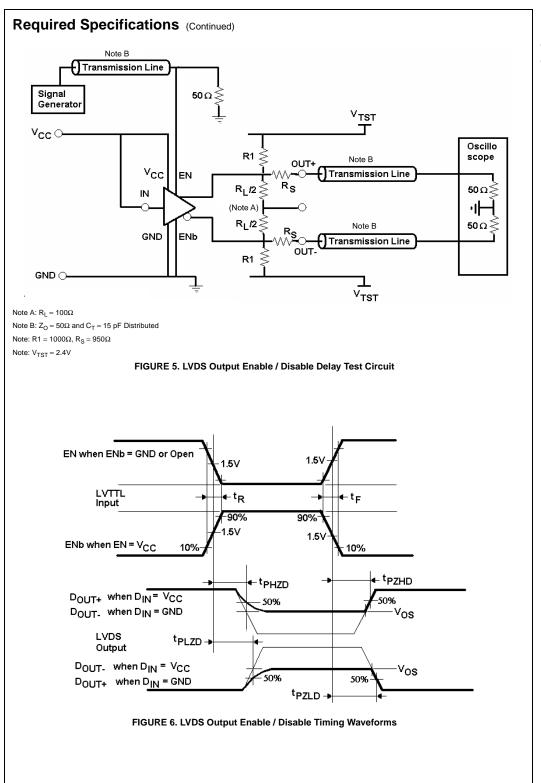


Note: $R_L = 100\Omega$

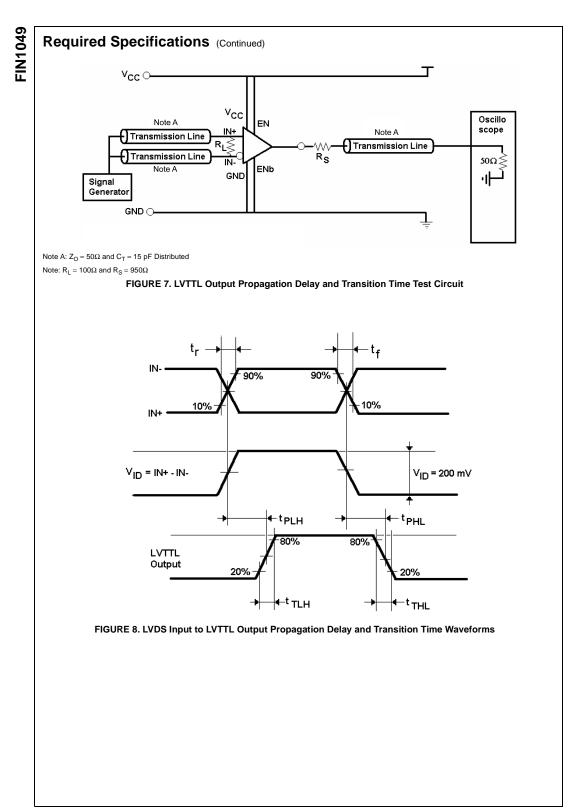
FIGURE 2. LVDS Output Circuit for DC Test

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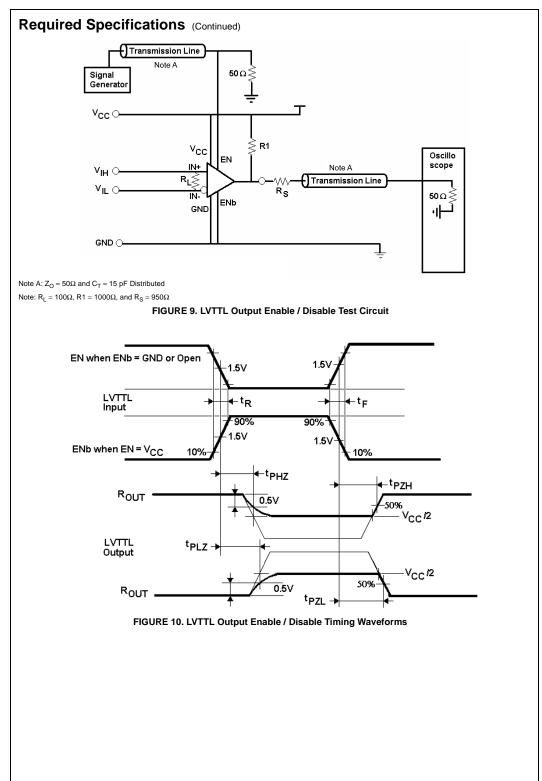








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